

Title (en)

NICKEL-FREE PHOSPHATIZATION PROCESS

Title (de)

NICKELFREIE PHOSPHATIERVERFAHREN

Title (fr)

PROCEDE DE PHOSPHATATION EXEMPTE DE NICKEL

Publication

EP 0633950 B1 19960515 (DE)

Application

EP 92924684 A 19921207

Priority

- DE 4210513 A 19920331
- EP 9202827 W 19921207

Abstract (en)

[origin: US6197126B1] The invention is a process for applying a nickel-free, copper-containing phosphate coating to a metal surface by contacting the metal surface with a phosphate solution containing 0.2 to 2.0 g/l zinc ions, 0.5 to 25 mg/l copper ions, and 5-30 g/l phosphate ions.

IPC 1-7

C23C 22/08; C23C 28/00

IPC 8 full level

B05D 3/10 (2006.01); **B05D 7/14** (2006.01); **C23C 22/08** (2006.01); **C23C 22/12** (2006.01); **C23C 22/17** (2006.01); **C23C 22/18** (2006.01); **C23C 22/22** (2006.01); **C23C 28/00** (2006.01)

CPC (source: EP US)

C23C 22/12 (2013.01 - EP US); **C23C 22/186** (2013.01 - EP US); **C23C 22/22** (2013.01 - EP US); **C23C 22/80** (2013.01 - EP); **Y10T 428/12583** (2015.01 - EP US)

Cited by

EP0675972A4; US6497771B1; WO9830732A1; WO9943868A1

Designated contracting state (EPC)

AT BE DE ES FR GB IT NL PT SE

DOCDB simple family (publication)

WO 9320259 A1 19931014; AT E138112 T1 19960615; CA 2133455 A1 19931014; DE 4210513 A1 19931007; DE 59206327 D1 19960620; EP 0633950 A1 19950118; EP 0633950 B1 19960515; ES 2086782 T3 19960701; JP H07505445 A 19950615; US 6197126 B1 20010306

DOCDB simple family (application)

EP 9202827 W 19921207; AT 92924684 T 19921207; CA 2133455 A 19921207; DE 4210513 A 19920331; DE 59206327 T 19921207; EP 92924684 A 19921207; ES 92924684 T 19921207; JP 51700792 A 19921207; US 31317994 A 19940930